



Examiner: A. Chambliss  
Art Unit: 2814

2814  
\$

THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : K. TATSUMI et al.  
Serial No. : 09/254,118  
Filed : May 19, 1999  
For : METHOD OF PARTIALLY PLATING SUBSTRATE FOR  
ELECTRONIC DEVICES

Assistant Commissioner  
for Patents  
Washington, D.C. 20231

TRANSMITTAL LETTER

SIR:

Transmitted herewith is an Amendment/Response in the  
above-identified patent application.

[X] No additional fee is required.

The fee has been calculated as shown below.

		SMALL ENTITY			OTHER THAN A SMALL ENTITY		
CLAIMS REMAINING AFTER AMENDMENT	HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDIT. OR FEE	RATE	ADDIT. FEE	
TOTAL 9 MINUS 20 = 0			x6 = \$		x18 = \$	0	
INDEP. 1 MINUS 3 = 0			x18 = \$		x80 = \$	0.00	
[ ] FIRST PRESENTATION OF MULTIPLE			x60 = \$		x270 = \$	0.00	
DEP. CLAIM			TOTAL				
			ADDIT. FEE	\$ OR		\$ 0.00	

[X] The Commissioner is hereby authorized to charge fees under  
37 CFR 1.16 and 1.17 which may be required to Deposit Account  
11-0600. A duplicate of this paper is enclosed.

[X] A petition for a three (3) month extension of time and Deposit  
Account authorization to cover the extension fee are enclosed.

Respectfully submitted,

KENYON & KENYON

I hereby certify that this correspondence is being deposited  
with the United States Postal Service as First Class Mail in  
an envelope addressed to: Assistant Commissioner for  
Patents, Washington, D.C. 20231 on August 7, 2001

John J. Kelly, Jr.

Reg. No. 29,182

By:

John J. Kelly, Jr.

Reg. No. 29,182